

ADHESIVE DESCRIPTION

ACRALOCK SF10 series are advanced, two component, 10:1 mix ratio, medium shear strength coupled with excellent toughness, high elongation universal bonding adhesives. SF 10 series is available in 5 min, 10 min and 30 min working times and are designed to bond as received aluminium, coated surfaces and many others without primers and with minimal to no other surface preparation^{a,b}. Due to its high elongation of around 300 % it is suitable to bond painted parts without crack of the paint layer and for other applications where the underground is not strong enough to withstand a high modulus structural adhesive.

Packaging options include 490 ml side by side cartridges and 20 l & 200 l drum containers for application with meter-mix dispensing equipment.

PERFORMANCE HIGHLIGHTS

- Working time 5, 10 and 30 minutes
- High Elongation
- Low Exotherm adhesives
- Gap fill 0,5 to 15 mm
- Good Environmental/Chemical Resistance^(b)
- Permanent toughness and elasticity
- No Sagging
- Non Critical mix ratio
- Stable formulations

BENEFITS

- Variety of working times available for assembly applications
- No surface cracks on painted/coated surfaces
- Reduced Print Through, less post finish work
- Thin film to High gap fill application possible
- Durable bond performance in harsh environments
- Excellent fatigue characteristics and shock load resistance
- Vertical surface and overhead applications possible
- Easy to use with cartridges and meter mixing equipment
- Shelf-life 6 months

PRODUCT PROPERTIES @ 22° C

Product	Adhesive/Activator	Working Time (Minutes)	Fixture Time (Minutes)
SF 10-05 BLK	SF 10-05A / 1 BBLK	4 - 7	>15
SF 10-10 GRY	SF 10-05A / 3 BGRY	8 - 10	>30
SF 10-30 GRY	SF 10-30A / 3BGRY	30 - 35	>60

TYPICAL ADHESIVE WET PROPERTIES

Property	Component A	Component B	A + B mixed
Colour	Off White	Black	Black
		Grey	Grey
Mix Ratio (Volume)	10	1	
Mix Ratio (Weight)	8,9	1	
Viscosity kps (Pa.s)	300 - 500	50 - 150	
Density (g/cm ³)	0,95 - 1,00	1,09 - 1,19	0,98 - 1,00

TYPICAL ADHESIVE CURED PHYSICAL PROPERTIES

- Tensile strength: 1.300 - 1.750 psi (9 - 12 MPa)
- Elongation: 250 - 300 %
- Lap Shear strength, ASTM D1002: 1.300 - 1.750 psi (8 - 10 MPa)
- Operating Temperature: - 55 - 120°C
- Max Temperature resistance: 200°C, 1h

Cured Adhesive is generally resistant to salt solutions, hydrocarbons and acid and bases with a PH from 3 to 10.

Cured Adhesive is not recommended for exposures to polar solvents and stronger acids or bases (see note b).

Operating Temperature range for this product is from - 55 to 120° C with intermittent exposure of -55 to 200° C (see note c)

RECOMMENDED SUBSTRATES (See important notes below)

Polyesters	Acrylics	PVC/FPVC/CPVC	Vinyl Esters
Polyester Gelcoats	ABS	Styrenics	Paints
Epoxies	Vinylesters	Stainless Steel ⁽⁴⁾	Carbon Steel ⁽⁴⁾
Aluminum	Topcoats	Coated Metals	Polyurethanes
PU - Rim	Polycarbonate	PMMA	PET
PVC	ESG/VSG Glas	Ceramic Coatings	

NOT RECOMMENDED FOR BONDING

Polyolefins	Polyacetals	PTFE	Galvanized Steel
Hot Dipped Galvanized Steel	Wood		

TYPICAL LAP SHEAR STRENGTH VALUES @ 22°C,

Carbonfibre epoxy laminate:	12 MPa ^(e) (cohesive failure)
Aluminium AW 6060	11 MPa ^(e) (cohesive failure)
Stainless Steel 1.4404	12 MPa ^(h) (cohesive failure)
Carbon Steel	11 MPa ^(h) (cohesive failure)
KTL:	12 MPa ^(e) (substrate failure)
PMMA:	5 MPa ^(e) (substrate failure)
ABS:	5 MPa ^(e) (substrate failure)
FRP:	7 MPa ^(e) (substrate failure)
Stainless steel:	10 MPa ^(g) (adhesive/cohesive failure)
Carbon steel:	9 MPa ^(g) (adhesive/cohesive failure)
Aluminium AW 6060:	11 MPa ^(f) (cohesive failure)
ABS:	5 MPa ^(f) (substrate failure)
KTL:	9 MPa ^(f) (substrate failure)
FRP:	7 MPa ^(f) (substrate failure)

^(e): bondline gap 1 mm, IPA wipe

^(h): bondline gap 1 mm, AP1 wipe

^(f): bondline gap 1 mm, IPA wipe, after Kataplasmatetestcycle, -30/+120°C, 12h each, 5 cycles

^(g): bondline gap 1 mm, AP1 wipe, after Kataplasmatetestcycle, -30/+120°C, 12h each, 5 cycles

IMPORTANT NOTES

- a.) Surface Preparation: The need for surface preparation must be determined by the user based on comparative testing of unprepared and prepared substrates to determine if strengths are adequate for application. Clean adhesive failure is not desired for long-term durable performance. In all cases initial shear strength tests must be followed up with simulated or actual durability tests to assure that surface conditions do not lead to degradation of the bond over time under service conditions. Subsequent changes in substrates or bonding conditions will require re-testing.
 1. Most thermoplastics listed above can be bonded with no surface preparation other than a dry wipe or air blow-off. If contamination is visible or suspected, wipe with alcohol prior to bonding. Low surface energy plastics like polyolefins, thermoplastic polyesters and fluorocarbon plastics are generally not bondable.
 2. Metals as received aluminum, stainless steel, cold rolled steel, carbon steel are bondable without preparation, EBS strongly suggest only using faster curing versions with working times less \leq 40 minutes, if bonding metal to metal in thin bond gaps $> 0,015''$ bond gap must be maintained.
 3. Thermoset composites are generally bonded without preparation, however mold releases and process can produce varied bonding performance and testing should be performed.
 4. Due to the wide range of different surfaces and qualities each single type has to be tested by the customer prior to use
- b.) It is the user's responsibility to determine the suitability of each adhesive for its intended use on substrates and application. EBS strongly recommends laboratory and end-use testing representative of the environmental conditions and how the bonded assembly will be used. Read and understand TDS and MSDS before using. Bonds are generally resistant to the effects of heat, water and moisture, aqueous chemicals and most petroleum hydrocarbons, including gasoline, motor oil and diesel fuel. Not recommended for immersion or long term exposure to concentrated acids or bases, or aggressive organic solvents such as toluene, ketones, and esters. It is the user's responsibility to determine the suitability of each adhesive for its intended use and application. Please contact EBS for technical assistance.
- c.) Cohesive strength at -40 and 120°C retains a minimum of 1,000psi as measured on aluminum. Bonds are resistant to intermittent exposures from -55 to 200°C, provided bonding assembly is in a fixture and not under shear load. User must determine suitability for continuous exposures beyond operating temperature range. The shelf life of Components A and B in unopened containers is approximately six months from the date the product is manufactured from EBS facilities. Shelf life is based on steady state storage between 55°F and 80°F (13°C and 27°C). Exposure, intermittent or prolonged, above 80°F/27°C will result in a reduction of the stated shelf life. Shelf life of both components can be extended by air-conditioned or refrigerated storage between 55°F and 65°F (13°C and 18°C).

Product recommendations contained herein are based on information we believe to be reliable.

All values presented above are typical properties obtained under controlled conditions at the EBS, LLC. laboratory or an outside certified laboratory. The values are intended to be used only as a guide for selection and further end-use evaluations. The ultimate suitability for any intended application must be verified by the END USER under their anticipated test conditions. This product is intended for use by skilled individuals at their own risk. Since specific use, materials and product handling are not controlled by EBS, our warranty is only limited to the replacement of defective EBS products.

SAFETY, HANDLING AND APPLICATION

VERY IMPORTANT: Read Material Safety Data Sheet before handling or using this product. Engineered Bonding Solutions, LLC (hereinafter referred to as “EBS”) adhesives are supplied in dual component cartridges, 5 gallon pails and 50 gallon drums to facilitate mixing through approved meter mix dispensing equipment. We do not suggest mixing by hand. Please contact your EBS representative for questions about dispensing equipment. The chemical reaction that occurs when components A and B are mixed generates heat. The amount of heat generated is controlled by the mass and thickness of the mixed product. Large masses over 12,5 mm thick can develop heat in excess of 250°F/121°C and generate harmful, flammable vapors. Larger curing masses should be carefully moved to a well-ventilated area where the chance of personal contact is minimized.

The working time is the approximate time that the adhesive remains fluid and will still wet the surface of the adherend after mixing component A (adhesive) and component B (activator). The fixture time is the approximate time after mixing the two components that allow the part to be moved or unclamped. This is generally shortly after exotherm is reached for particular bonding condition. Parts can generally be put in service when 75 percent of full strength is developed, which occurs once the bonded assembly has cooled back to ambient temperatures. Higher ambient temperatures will shorten the working time and colder temperatures will lengthen the working time. The reported data presented in the TDS are based on tests conducted under laboratory conditions of 75°F/24°C. For applications in hot or cold ambient conditions please contact your EBS representative.

Prior to bonding, ensure substrates are clean and free of surface contaminants. All dispensing equipment should be in good operating condition and QC ratio checks performed periodically to ensure consistent and accurate dispensing. Use only adhesive dispensing equipment approved by your EBS sales representative. All wetted metal parts should be stainless steel, always purge enough adhesive on a non-porous surface (frp or plastic) to ensure proper mixed color is maintained. Check the cure profile to ensure the working time and fixture time match the reported values for A and B components listed on the front page. If all QC checks are in order, continue with the assembly operation and be careful to ensure that parts are bonded to a minimum gap thickness of 0.02”(.5mm) and maximum gap of 0.5” (12,5 mm). *All adhesives with working times below 30 minutes can boil in gaps approaching 12,5 mm or even less if using even faster formulas. This could lead to reduced physical properties.* After the adhesive is fully applied, consistent pressure should be applied to allow squeeze out, then also, parts should not be repositioned once substrates are bonded. Any movement of parts will entrap air in the bonded joints, which will reduce performance. The bonded assembly should then be clamped in position and not be disturbed until the fixture time has elapsed.

EBS recommends the use of alcohol or industrial solvents for cleaning excess adhesive. This should be done when the adhesive is still wet or soft and care must be taken to prevent the cleaning solvent or alcohol from coming in contact with the adhesive as this could lead to an under-cure of the exposed edges. The use of tape and a sharp edge to remove excess adhesive is best practice. Also, partially cured adhesive can be carefully removed with a sharp knife. Removal of cured adhesive should be scraped or cut with a sharp blade which is preferred to sanding or grinding. High speed sanding or grinding of large areas will produce heat and produce noxious fumes and should be avoided or only be done with protective breathing apparatus.